

### **Inductors for Power Circuits**

Wound Metallic Magnetic Material

**SPM Series** 

# SPM3012 Type

SPM3012

### **A** Caution

## The products in this catalog will be or have been stopped production

Discontinue Issue Date	Jun. 3, 2022				
Last Purchase Order Date	Sep. 30, 2023				
Last Shipment Date	Mar. 31, 2024				

Please refer to our Web site about replacement information.



### REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

### SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

#### **∧** REMINDERS O The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. O Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.). O Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C. Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur. O When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions. Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design. Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference. O Use a wrist band to discharge static electricity in your body through the grounding wire. O Do not expose the products to magnets or magnetic fields. O Do not use for a purpose outside of the contents regulated in the delivery specifications. O The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications) equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us. (1) Aerospace/Aviation equipment (8) Public information-processing equipment (2) Transportation equipment (cars, electric trains, ships, etc.) (9) Military equipment (3) Medical equipment (10) Electric heating apparatus, burning equipment (4) Power-generation control equipment (11) Disaster prevention/crime prevention equipment (5) Atomic energy-related equipment (12) Safety equipment (6) Seabed equipment (13) Other applications that are not considered general-purpose applications (7) Transportation control equipment When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

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### Inductors for Power Circuits Wound Metallic Magnetic Material

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Product compatible with RoHS directive Halogen-free Compatible with lead-free solders

### **Overview of SPM3012 Type**

#### FEATURES

O Magnetic shield type wound inductor for power circuits using a metallic magnetic material.

- O Low-profile product.
- O Compared to ferrite wound type inductors, it is possible to achieve large current, low Rdc, and compactness.
- O Low inductance variance in high-temperature environments with good DC superimposition characteristics.
- O Metallic magnetic material is used, and the structure has an integrated molded coil, so hum noise is lower than with core adhesive coils.

#### APPLICATION

Smart phones, tablet terminals, laptop computers, HDDs, servers, VRMs, compact power supply modules, other

#### PART NUMBER CONSTRUCTION



#### OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

	Temperat	ure range	Package quantity	Individual weight
Туре	Operating temperature*	Storage temperature**		
		(°C)	(pieces/reel)	(g)
SPM3012	-40 to +125	-40 to +125	2000	0.047
*	1 1 1 10 10 1			

\* Operating temperature range includes self-temperature rise.
\*\* The Storage temperature range is for after the circuit board is mounted.

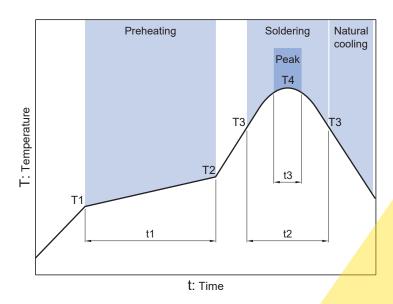
RoHS Directive Compliant Product: See the following for more details related to RoHS Directive compliant products. http://product.tdk.com/en/environment/rohs/
Halogen-free: Indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.

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### INDUCTORS

### SPM3012 Type

### RECOMMENDED REFLOW PROFILE



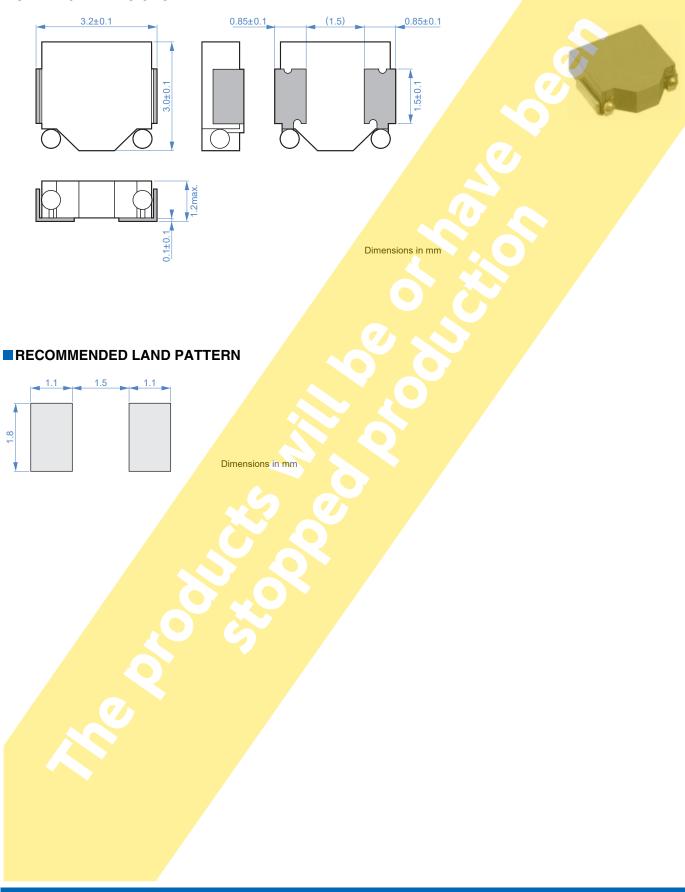
Preheatir	ng		Soldering		Peak		
Temp.		Time	Temp. T	me	Temp.	Time	
T1	T2	t1	T3 t2		T4	t3	
150°C	180°C	120s	230°C 30	IS	260°C	10s max.	

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### INDUCTORS

### SPM3012 Type

#### SHAPE & DIMENSIONS



### SPM3012 Type

### ELECTRICAL CHARACTERISTICS

#### **CHARACTERISTICS SPECIFICATION TABLE**

L		L measuring frequency	DC resistar	ice	Rated cur	rent*		Part No.
(µH)	Tolerance	(kHz)	(m $\Omega$ )max.	(mΩ)typ.	lsat (A)max.	lsat (A)typ.	Itemp (A)typ.	
1.0	±20%	100	62.7	57	3.4	4.5	2.8	SPM3012T-1R0M
1.5	±20%	100	84.7	77	2.8	3.8	2.5	SPM3012T-1R5M
2.2	±20%	100	110	100	2.5	3.3	2.2	SPM3012T-2R2M
3.3	±20%	100	210.5	183	1.8	2.4	1.5	SPM3012T-3R3M
4.7	±20%	100	266.8	232	1.5	2.0	1.3	SPM3012T-4R7M

\* Rated current: smaller value of either lsat or Itemp.

Isat: When based on the inductance change rate (30% below the initial value)

Itemp: When based on the temperature increase (Temperature increase of 40°C by self heating)

#### $\bigcirc$ Measurement equipment

Measurement item	Product No.	Manufacturer	
L	4284A	Agilent Technologies	
DC resistance	AX-111A	ADEX	
Rated current Isat	4284A+42841A+42842C	Agilent Technologies	

\* Equivalent measurement equipment may be used.

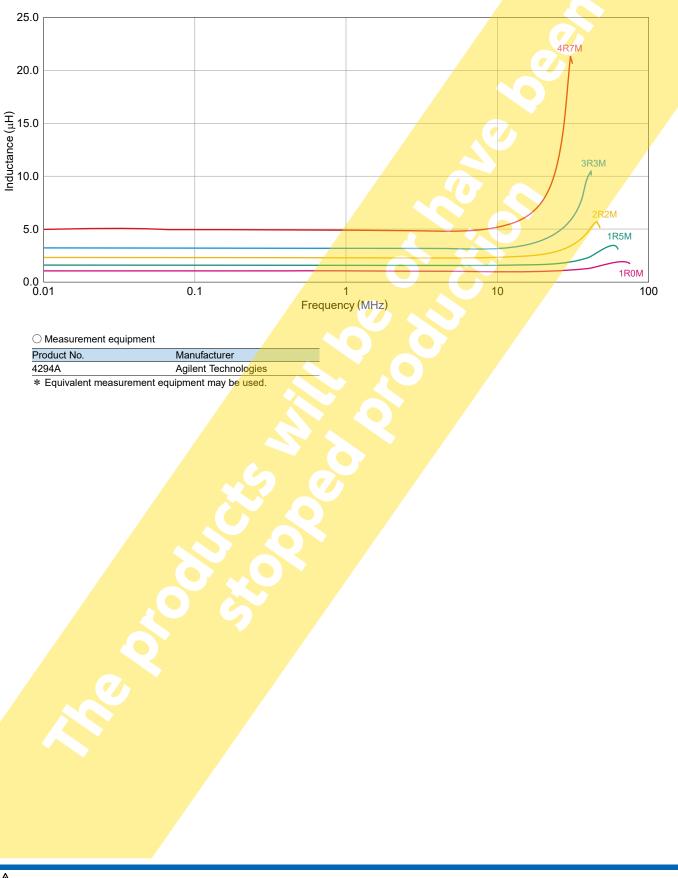
A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

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### SPM3012 Type

### ELECTRICAL CHARACTERISTICS

#### L FREQUENCY CHARACTERISTICS GRAPH



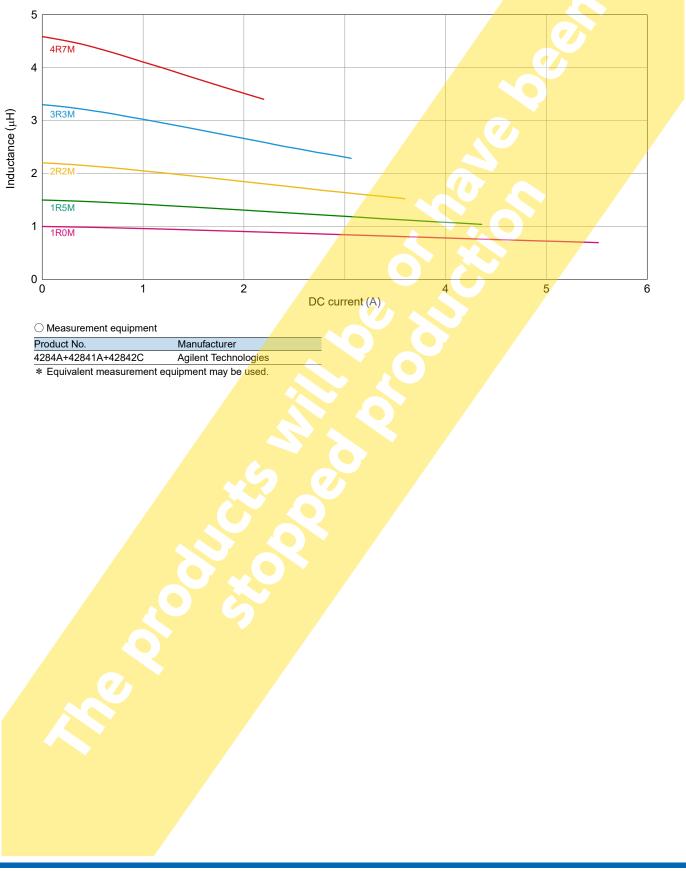
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### SPM3012 Type

### ELECTRICAL CHARACTERISTICS

□ INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH



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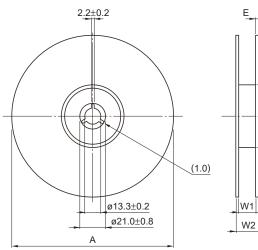
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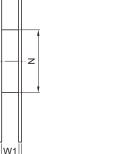
### INDUCTORS

### SPM3012 Type

#### PACKAGING STYLE

**REEL DIMENSIONS** 





Туре

Dimensions in mm

SPM3012 Ø178

А

\* These values are typical values.

W1

9.5

W2

11.9

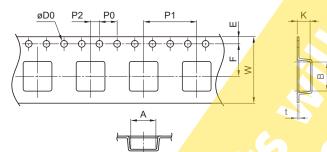
N

ø60

12

Dimensions in mm

#### **TAPE DIMENSIONS**



Туре	А	В	øD0	E	F	P0		P1	P2	W	K	t
SPM3012	3.3	3.5	1.5+0.1/-0	1.75±0.1	3.50±0.05	4.0±0.1	7	8.0±0.1	2.0±0.05	8.0±0.2	1.35	0.25